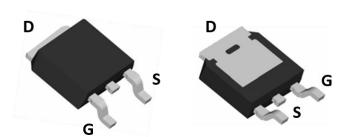




N-Channel Enhancement Mode Field Effect Transistor



Product Summary

• V_{DS} 40V • I_D 60A

 $\bullet \ \mathsf{R}_{\mathsf{DS}(\mathsf{ON})} (\ \mathsf{at} \ \mathsf{V}_{\mathsf{GS}} \!\!=\!\! 10 \mathsf{V}) \\ \phantom{\mathsf{ON}} < 7.0 \ \mathsf{mohm}$

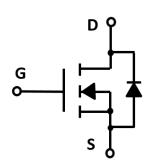
• R_{DS(ON)}(at V_{GS}=4.5V)

< 9.5 mohm

• 100% UIS Tested

100% ∇V_{DS} Tested





General Description

- Trench Power LV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low R_{DS(ON)}

Applications

- High current load applications
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

■ Absolute Maximum Ratings (T_A=25 °C unless otherwise noted)

Р	arameter	Symbol	Limit	Unit	
Drain-source Voltage		V_{DS}	40	V	
Gate-source Voltage		V_{GS}	±20	V	
Drain Current	T _C =25℃	1	60	А	
Drain Current	T _C =100°C	· I _D	42		
Pulsed Drain Current ^A		I _{DM}	200	А	
Total Power Dissipation	T _C =25℃	P _D	70	W	
	T _C =100°C	P _D	35	W	
Single Pulse Avalanche Energy ^B		E _{AS}	70	mJ	
Thermal Resistance Junction-to-Case ^C		R _{eJC}	R _{BJC} 2.3		
Junction and Storage Temperature Range		T _J ,T _{STG}	T _J ,T _{STG} -55∼+175		

■ Ordering Information (Example)

PREFERED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJD60N04A	F1	YJD60N04A	2500	2500	25000	13" reel



■ Electrical Characteristics (T_J=25 °C unless otherwise noted)

Parameter	Symbol	Conditions		Min	Тур	Max	Units
Static Parameter		,		1			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA		40			V
7. 0. 11. 2. 0		T _J =25℃				1	۵
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	Tյ=55°C			5	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20	V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} = V _{GS} ,	I _D =250μA	0.7	1.3	2	V
Chatia Dunia Carras On Decistance	R _{DS(ON)}	V _{GS} = 10V, I _D =20A			5.4	7	mΩ
Static Drain-Source On-Resistance		V _{GS} = 4.5V, I _D =10A			6.8	9.5	
Diode Forward Voltage	V_{SD}	I _S =10A,	V _{GS} =0V		0.8	1.2	V
Maximum Body-Diode Continuous Current	Is					60	А
Dynamic Parameters							
Input Capacitance	C _{iss}	V _{DS} =20V,V _{GS} =0V,f=1MHZ			1500		pF
Output Capacitance	C _{oss}				224		
Reverse Transfer Capacitance	C _{rss}				152		
Switching Parameters							
Total Gate Charge	Q_g	V _{GS} =10V,V _{DS} =20V,I _D =20A			29		nC
Gate-Source Charge	Q_{gs}				6		
Gate-Drain Charge	Q_{gd}				7		
Reverse Recovery Chrage	Q_{rr}	I _F =20A, di/dt=100A/us			21		
Reverse Recovery Time	t _{rr}				40		
Turn-on Delay Time	t _{D(on)}	V_{GS} =10V, V_{DD} =20V, I_{D} =2A, R_{L} =1 Ω R_{GEN} =3 Ω			6		ns
Turn-on Rise Time	t _r				36		
Turn-off Delay Time	$t_{D(off)}$				29		
Turn-off fall Time	t _f				7		

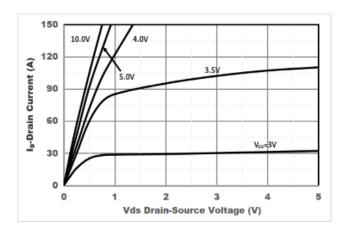
A. Pulse Test: Pulse Width≤300us, Duty cycle ≤2%.

B. $T_j=25$ °C, $V_{DD}=20$ V, $V_G=10$ V, L=0.5mH, $R_g=25$ Ω

C. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.



■ Typical Performance Characteristics





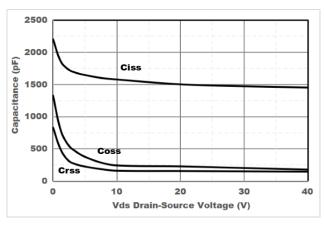


Figure 3. Capacitance Characteristics

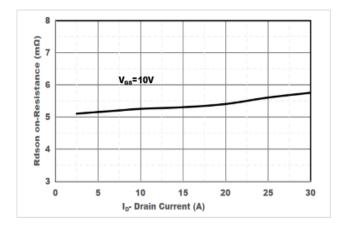


Figure 5. Drain-Source on Resistance

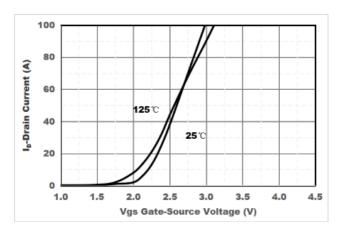


Figure 2. Transfer Characteristics

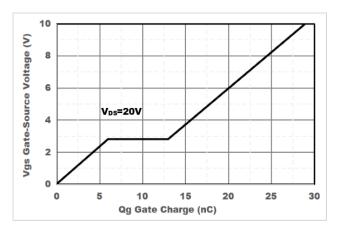


Figure 4. Gate Charge

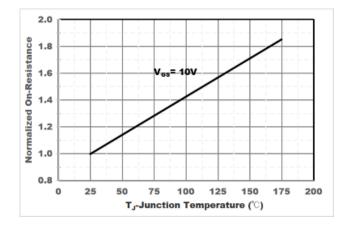


Figure 6. Drain-Source on Resistance



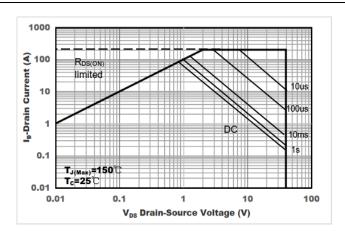


Figure 7. Safe Operation Area

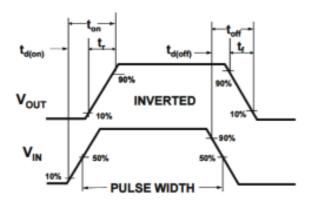
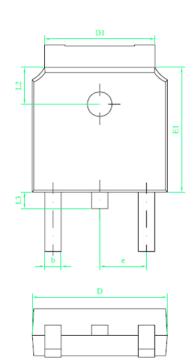
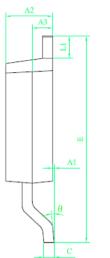


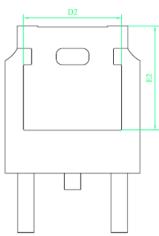
Figure8. Switching wave



■ TO-252 Package information







符号	尺寸					
10 3	min	nom	max			
A1	0		0.10			
A2	2.20	2.30	2.40			
A3	0.90	1.00	1.10			
b	0.75		0.85			
С	0.50		0.60			
D	6.50	6.60	6.70			
D1	5.30	5.40	5.50			
D2	4.70	4.80	4.90			
Е	9.90	10.10	10.30			
E1	6.00	6.10	6.20			
E2	5.20	5.30	5.40			
c	2.20	2.286	2.40			
L1	0.90		1.25			
L2	1.70	1.80	1.90			
L3	0.60	0.80	1.00			
θ	0°		8°			

技术要求:

- 1. 树脂体不应有崩裂、缺损等缺陷:
- 2. 树脂上下部X、Y方向偏差不超过0. 20;
- 3. 胶体两端留废胶总和宽度不超过0.50;
- 4. 所有单位为mm;



Disclaimer

The information presented in this document is for reference only. Yangzhou Yangjie Electronic Technology Co., Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website http:// www.21yangjie.com, or consult your nearest Yangjie's sales office for further assistance.